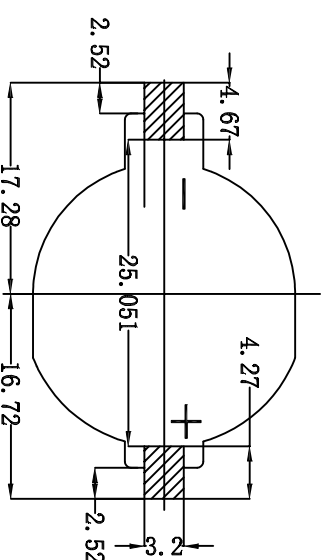
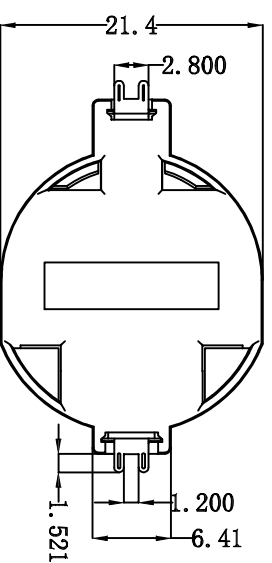
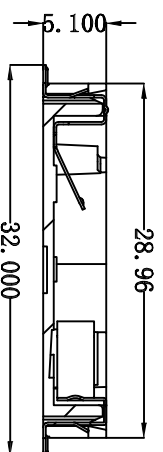
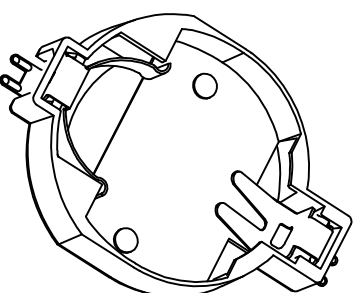
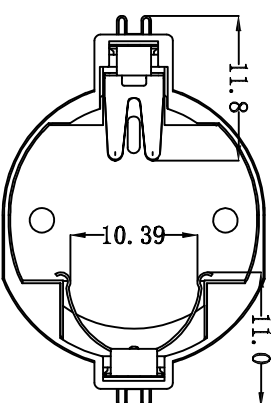




PCB Layout Diagram
Top View

NOTE:

1. MATERIAL:

- a. HOUSING: THERMOPLASTIC GLASS FIBRE UL94V-0
b. CONTACT: PHOSPHOR BRONZE
(SURFACE PLATING: Au*U")

SEE ORDERING INFORMATION

2. ELECTRIC:

- a. CONTACT RESISTANCE: 30 MILLIOHMS MAX
b. INSULATION RESISTANCE: 1000 MEGA OHMS MIN
c. DIELECTRIC VOLTAGE: 500V AC ONE SEC LEVEL
d. OPERATING TEMPERATURE: -25° C ~ +85° C

3	TERMINAL (-)	1	PHOSPHOR BRONZE, T=0.20MM	Gold Plating and Ni Under-Plating
2	TERMINAL (+)	1	PHOSPHOR BRONZE, T=0.20MM	Gold Plating and Ni Under-Plating
1	HOUSING	1	PPS	BROWN
NO.	PART NAME	QTY	MATERIAL	PLATING & COLOR
	A		NEW	
ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.

APPROVALS		DATE		GEPU歌普 電池座 SONY SMT					
DRAWN	ZHIWEI.CHEN	2015.07.07							
CHECKED									
APPROVALS									
TOLERANCES ARE		30~0.01E 10~0.30 5~10 ~5	±0.30 ±0.20 ±0.15 ±0.10	ANGLE	±2°	UNIT: mm	SCALE: 1:1	PROD. 	
						DRAWING NO.		SHEET 1 OF	